

Agilent N5182A MXG and N5162A MXG ATE **Vector Signal Generators**

Data Sheet Optimized for Performance and Speed

· Fast switching speeds

· Industry-best ACPR





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Definitions

Specification (spec): Represents warranted performance of a calibrated instrument that has been stored for a minimum of 2 hours within the operating temperature range of 0 to 55 °C, unless otherwise stated, and after a 45 minute warm-up period. The specifications include measurement uncertainty. Data represented in this document are specifications unless otherwise noted.

Typical (typ): Represents characteristic performance, which 80% of the instruments manufactured will meet. This data is not warranted, does not include measurement uncertainty, and is valid only at room temperature (approximately 25 °C).

Nominal (nom): The expected mean or average performance, or an attribute whose performance is by design, such as the 50 Ω connector. This data is not warranted and is measured at room temperature (approximately 25 °C).

Measured (meas): An attribute measured during the design phase for purposes of communicating expected performance, such as amplitude drift vs. time. This data is not warranted and is measured at room temperature (approximately 25 °C).

Note: All graphs contain measured data from several units at room temperature unless otherwise noted.

Frequency

Range

Option 503 100 kHz to 3 GHz Option 506 100 kHz to 6 GHz

Minimum frequency 100 kHz ¹

Resolution 0.01 Hz

Phase offset Adjustable in nominal 0.1 ° increments

Frequency bands ²

Band	Frequency range	N	
1	100 kHz to < 250 MHz	1	
2	250 to < 375 MHz	0.25	
3	375 to < 750 MHz	0.5	
4	750 to < 1500 MHz	1	
5	1500 to < 3000.001 MHz	2	
6	3000.001 to 6000 MHz	4	

Switching speed ^{3, 4, 6}

Туре	Standard	Option UNZ ⁵	Option UNZ ⁵ (typical)
Digital modulation off			
SCPI mode	\leq 5 ms (typ)	≤ 1.15 ms	≤ 950 µs
List/Step sweep mode	\leq 5 ms (typ)	≤ 900 µs	≤ 700 µs
Digital modulation on			
SCPI mode	\leq 5 ms (typ)	≤ 1.15 ms	≤ 1.05 ms
List/Step sweep mode	\leq 5 ms (typ)	≤ 900 µs	≤ 800 µs

Performance below 250 kHz is unspecified except as indicated, for units with serial numbers ending with 4742xxxx or greater. For units with lower serial numbers refer to the Archive Section at end of this document.

^{2.} N is a factor used to help define certain specifications within the document.

^{3.} Time from receipt of SCPI command or trigger signal to within 0.1 ppm of final frequency or within 100 Hz, whichever is greater, and amplitude settled to within 0.2 dB.

Additional time may be required for the amplitude to settle within 0.2 dB when switching to or from frequencies < 500 kHz.

^{5.} Specifications apply when status register updates are off.

^{6.} With Internal Channel Corrections on, the frequency switching speed is < 1 ms (measured) for list mode and SCPI mode cached frequency points. For the initial frequency point in SCPI mode the time is < 75 ms (measured). The instrument will automatically cache the most recently used 256 frequencies. There is no speed degradation for amplitude-only changes. Internal Channel Correction applies to FW A.01.60 or greater with Option N5162/82AK-R2C.</p>

Accuracy ± aging rate

± temperature effects ± line voltage effects

Internal time base reference

oscillator aging rate $\leq \pm 5 \text{ ppm/10 yrs, } < \pm 1 \text{ ppm/yr (nom)}^{-1}$

Temperature effects $\pm 1 \text{ ppm } (0 \text{ to } 55 \text{ °C}) \text{ (nom)}$

Line voltage effects \pm 0.1 ppm (nom); 5% to -10% (nom)

Reference output

Frequency 10 MHz

Amplitude $\geq +4 \text{ dBm (nom) into } 50 \Omega \text{ load}$

External reference input

Input frequency Standard Option 1ER

10 MHz 1 to 50 MHz (in multiples of 0.1 Hz)

Lock range ± 1 ppm

Amplitude > -3.5 to 20 dBm (nom)

 $\begin{array}{ll} \text{Impedance} & \quad 50 \; \Omega \; (\text{nom}) \\ \text{Waveform} & \quad \text{Sine or square} \end{array}$

Digital sweep modes

Operating modes Step sweep (equally or logarithmically spaced

frequency steps)

List sweep (arbitrary list of frequency steps)

Can also simultaneously sweep amplitude and waveforms. See amplitude and baseband generator sections

for more detail.

Sweep range Within instrument frequency range

Dwell time 100 µs to 100 s

Number of points 2 to 65535 (step sweep)

1 to 3201 (list sweep)

Step change Linear or logarithmic

Triggering Free run, trigger key, external, timer,

bus (GPIB, LAN, USB, LXI LAN, LXI ALARM 2)

^{1.} Aging rate is determined by design as a function of the TCXO. It is not specified.

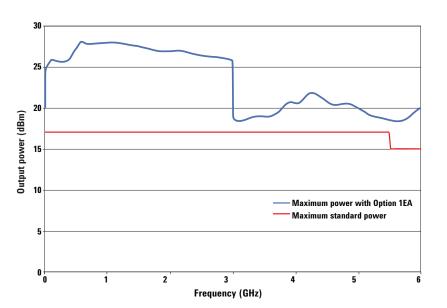
^{2.} LXI class B requires Option ALB. Standard on new instruments.

Amplitude

Output power 1

 $\begin{array}{ll} \mbox{Minimum output power} & \mbox{-110 dBm} \\ \mbox{with Option 1EQ} & \mbox{-127 dBm}^2 \end{array}$

Range	Standard ³	Option 1EA
100 kHz to 50 MHz	+13 dBm	+15 dBm
> 50 MHz to 3 GHz	+13 dBm	+23 dBm
> 3 GHz to 5.0 GHz	+13 dBm	+17 dBm
> 5.0 GHz	+11 dBm	+16 dBm



Reso	lution	
------	--------	--

0.01 dB (nom)

Step attenuator

0 to 130 dB in 5 dB steps (110 dB without Option 1EQ), electronic type

Connector

Oominecto

50 Ω (nom)

SWR⁴

1.4:1 (typ)
1.55:1 (typ)
1.7:1 (typ)
1.6:1 (typ)

Maximum reverse power

Max DC voltage 50 VDC (nom) 100 kHz to 6 GHz 2 W (nom)

- Specifications apply to units with serial numbers ending with 4818xxxx or greater.
 For units with lower serial numbers refer to the Archive Section at the end of this document.
- SWR values apply to units with serial numbers ending with 4818xxxx or greater.
 For units with lower serial numbers refer to the Archive Section at end of this document.

Quoted specifications between 20 and 30 °C. Maximum output power typically decreases by 0.04 dB/°C for temperatures outside this range.

^{2.} Settable to -144 dBm with Option 1EQ, but unspecified below -127 dBm.

Switching speed ^{1, 2}

Туре	Standard	Option UNZ	Option UNZ typical
Digital modulation off			
SCPI mode	≤ 5 ms (typ)	≤ 750 μs	≤ 650 µs
List/Step sweep mode	≤ 5 ms (typ)	≤ 500 μs	≤ 400 μs
Digital modulation on			
SCPI mode	≤ 5 ms (typ)	≤ 1.15 ms	≤ 950 µs
List/Step sweep mode	≤ 5 ms (typ)	≤ 900 µs	≤ 700 µs

Absolute level accuracy in CW mode ³ [ALC on]

_		Standard	Option 1EQ
+	23 ⁵ to -60 dBm	<-60 to -110 dBm	< -110 to -127 dBm
100 kHz to 250 kHz 4	±0.6 dB	±1.0 dB	_
> 250 kHz to 1 MHz	±0.6 dB	±0.7 dB	±1.7 dB
> 1 MHz to 1 GHz	±0.6 dB	±0.7 dB	±1.0 dB
> 1 to 3 GHz	±0.6 dB	±0.8 dB	±1.1 dB
> 3 to 4 GHz	±0.7 dB	±0.8 dB	±1.1 dB
> 4 to 6 GHz	±0.8 dB	±1.1 dB	±1.3 dB

Time from receipt of SCPI command or trigger signal to amplitude settled within 0.2 dB. For units with serial numbers ending in 4742xxxx or less, switching speed is specified for power levels < +5 dBm.

^{2.} Switching speed specifications apply when status register updates are off.

^{3.} Quoted specifications between 20 °C and 30 °C. For temperatures outside this range, absolute level accuracy degrades by 0.005 dB/°C for frequencies ≤ 4.5 GHz and 0.01 dB/°C for frequencies > 4.5 GHz. Output power may drift up to .003 dB per g/Kg change in specific humidity (nom)

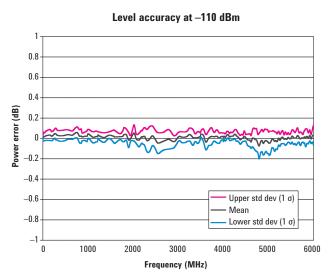
^{4.} Specification applies to units with serial numbers ending with 4818xxxx or greater.

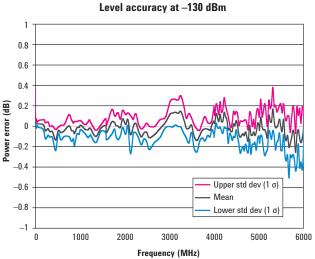
^{5.} For units with lower serial numbers refer to the Archive Section at end of this document, or maximum specified output power, whichever is lower.

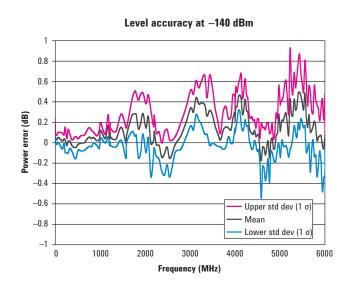
Absolute level accuracy in CW mode [ALC off, relative to ALC on] ±0.35 dB (typ)

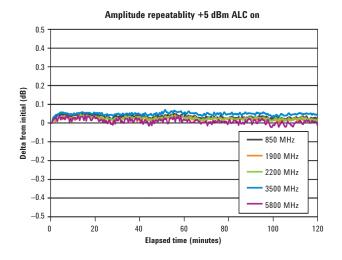
Absolute level accuracy in digital I/Q mode [ALC on, relative to CW]

300 MHz to 2.5 GHz	±0.25 dB
3.3 to 3.8 GHz	±0.45 dB
5.0 to 6.0 GHz	±0.25 dB

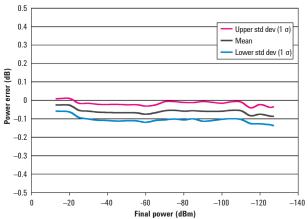






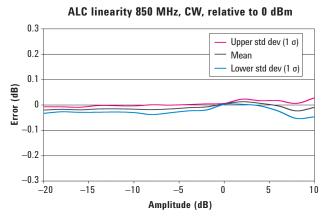


Relative level accuracy at 850 MHz initial power +10 dBm

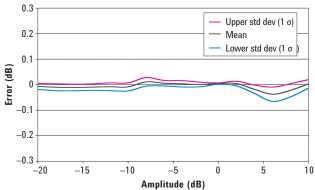


Repeatability measures the ability of the instrument to return to a given power setting after a random excursion to any other frequency and power setting. It should not be confused with absolute level accuracy.

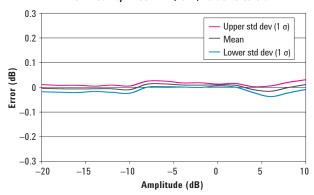
Relative level accuracy measures the accuracy of a step change from any power level to any other power level. This is useful for large changes (i.e. 5 dB steps).



ALC linearity 1900 MHz, CW, relative to 0 dBm

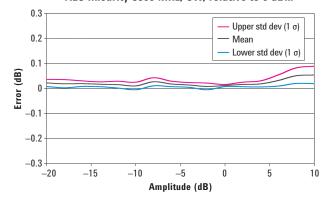


ALC linearity 2200 MHz, CW, relative to 0 dBm

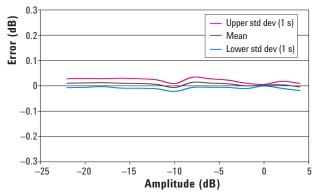


Linearity measures the accuracy of small changes while the attenuator is held in a steady state. This is useful for fine resolution changes.

ALC linearity 3500 MHz, CW, relative to 0 dBm



ALC linearity 5800 MHz, CW, relative to 0 dBm



User flatness correction

Number of points 3201

Number of tables Dependent on available free memory in instrument;

10,000 maximum

Entry modes USB/LAN direct power meter control, LAN to GPIB and USB

to GPIB, remote bus and manual USB/GPIB power meter control

Digital sweep modes

Operating modes Step sweep (evenly spaced amplitude steps)

List sweep (arbitrary list of amplitude steps)

Can also simultaneously sweep frequency and waveforms. See frequency and baseband generator sections for more detail.

Sweep range Within instrument amplitude range

Dwell time $100 \mu s$ to 100 s

Number of points 2 to 65535 (step sweep)

1 to 3201 (list sweep)

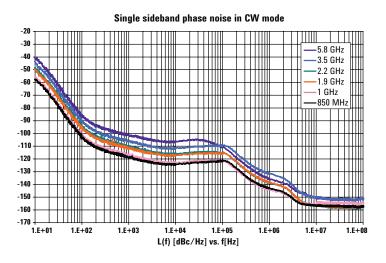
Step change Linear

Triggering Free run, trigger key, external, timer, bus (GPIB, LAN, USB)

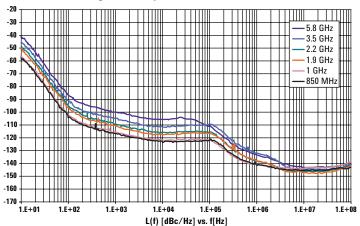
Spectral Purity

Single sideband phase noise [at 20 kHz offset]

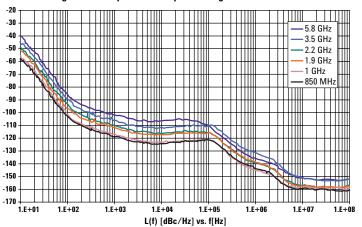
500 MHz	$\leq -126 \text{ dBc/Hz (typ)}$	3 GHz	\leq -110 dBc/Hz (typ)
1 GHz	\leq -121 dBc/Hz (typ)	4 GHz	\leq -109 dBc/Hz (typ)
2 GHz	\leq -115 dBc/Hz (typ)	6 GHz	\leq -104 dBc/Hz (typ)



Single sideband phase noise with $\ensuremath{\mathrm{I}}/\ensuremath{\mathrm{0}}$ modulation

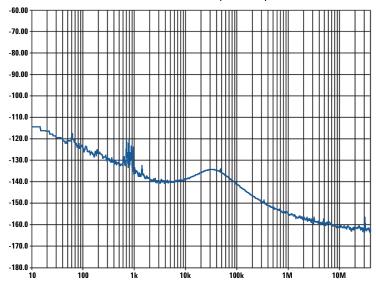






Signal-to-noise optimized mode will improve broadband noise floor. In this mode, other specifications may not apply. Applies to instrument serial number prefix 4818xxxx, or above.





Residual FM [CW mode, 300 Hz to 3 kHz BW, CCITT, rµs] < N x 2 Hz (typ)

Harmonics ¹ [CW mode, output level]

Range	(< +4 dBm)	1EA (< +12 dBm)
250 kHz to 3 GHz	<-35 dBc	<-30 dBc
> 3 to 4 GHz	< -41 dBc (typ)	< -30 dBc (typ)
> 4 to 6 GHz	< -53 dBc (typ)	< -40 dBc (typ)

Nonharmonics 1 [CW mode]

> 10 kHz offset

250 kHz to 250 MHz	< -62 dBc, < -70 dBc (typ)
> 250 to 375 MHz	< -68 dBc, < -81 dBc (typ)
> 375 to 750 MHz	< -57 dBc, < -73 dBc (typ)
> 750 MHz to 3 GHz	< -54 dBc, < -62 dBc (typ)
> 3 to 6 GHz	< -47 dBc, $<$ -56 dBc (typ)

Subharmonics ¹ [CW mode]

250 kHz to 3.0 GHz	< -73 dBd
> 3.0 to 4.5 GHz	< -68 dBd
> 4.5 to 5.5 GHz	< -56 dBd
> 5.5 to 6 GHz	< -52 dBd

Jitter ²

Carrier		SONET/SDH				
Freque	псу	Data rate	rms jitter BW	μUI rms	Femtoseconds	
155 M	Hz	155 MB/s	100 Hz to 1.5 MHz	84	537	
622 M	Hz	622 MB/s	1 kHz to 5 MHz	47	75	
2.488 (GHz	2488 MB/s	5 kHz to 20 MHz	178	72	

Phase coherence (Option 012)

- LO input frequency range: 250 MHz to 6 GHz (nom)
- LO input power: 0 dBm to +7 dBm (nom)
- LO output frequency range: 250 MHz to 6 GHz (nom)
- LO output power: 0 dBm to +7 dBm (nom)
- Harmonics, subharmonics, and non-harmonics apply to instruments with serial number prefixes 4818xxxx or greater and are typical outside the frequency range of the instrument. Refer to the Archive Section at end of this document for specifications for units with lower serial numbers.
- Calculated from phase noise performance in CW mode at +10 dBm. For other frequencies, data rates, or bandwidths, please consult your sales representative.

Analog Modulation

Frequency modulation ¹

(Option UNT)

Max deviation $N \times 10 \text{ MHz (nom)}$

Resolution 0.1% of deviation or 1 Hz, which ever is greater (nom)

Deviation accuracy

[1 kHz rate, deviation $< \pm 2\% + 20$ Hz

is N x 50 kHz]

Modulation frequency response [at 100 kHz rate]

1 dB bandwidth 3 dB bandwidth DC coupled DC to 3 MHz (nom) DC to 7 MHz (nom) AC coupled 5 Hz to 3 MHz (nom) 5 Hz to 7 MHz (nom) Carrier frequency accuracy $< \pm 0.2\%$ of set deviation + (N × 1 Hz) ² $< \pm 0.06\%$ of set deviation + (N × 1 Hz) (typ) ³ relative to CW in DCFM Distortion [1 kHz rate, deviation < 0.4% is $N \times 50 \text{ kHz}$

Sensitivity when using +1 V peak for indicated deviation (nom)

external input

Phase modulation ¹

(Option UNT)

Modulation deviation and frequency response:

	iviax aev	3 ab danawiath
Normal BW	N × 5 radians (nom)	DC to 1 MHz (nom)
High BW mode	$N \times 0.5$ radians (nom)	DC to 4 MHz (nom)
Resolution	0.1% of deviation (nom)	
Deviation accuracy [1 kH	< +0.5% + 0.01 rad (typ)	
Distortion [1 kHz rate, de	< 0.2% (typ)	
Sensitivity when using e	+1 V peak for indicated	
		deviation (nom)

Amplitude modulation ⁴

(Option UNT)

AM depth type Linear or exponential

Depth

Maximum 100%

Resolution 0.1% of depth (nom)
Depth accuracy [1 kHz rate] < ±4% of setting +1% (typ)

Modulation rate [3 dB BW]

DC coupled 0 to 10 kHz (typ)
AC coupled 5 Hz to 10 kHz (typ)

Distortion [1 kHz rate, 90% depth] < 2% (typ)

Sensitivity when using external input +1 V peak for indicated depth (nom)

Wideband AM

Rates

ALC on 800 Hz to 50 MHz (nom)
ALC off DC to 50 MHz (nom)

Wideband AM

Sensitivity 0.25 V = 100%Input Impedence 50Ω , nominal

N is a factor used to help define certain specifications. Refer to page 4 for N

^{2.} Specification valid for temperature changes of less than \pm 5 °C since last DCFM calibration.

Typical performance immediately after a DCFM calibration.

^{4.} AM is specified at carrier frequencies from 1 MHz to 3 GHz, power levels ≤ ±4 dBm, and with ALC on and envelope peaks within ALC operating range (-20 dBm to maximum specified power, excluding step-attenuator setting).

Internal analog modulation source

(Single sine wave generator for use with AM, FM, phase modulation. Requires Option UNT)

Waveform Sine

Rate range 0.1 Hz to 2 MHz (tuneable to 3 MHz)

Resolution 0.1 Hz

Frequency accuracy Same as RF reference source (nom)

Pulse modulation

(Option UNU) 1

 $\begin{array}{lll} \text{On/Off ratio} & > 80 \text{ dB (typ)} \\ \text{Rise time} & < 50 \text{ ns (typ)} \\ \text{Fall time} & < 50 \text{ ns (typ)} \end{array}$

Minimum width

 $\begin{array}{lll} \mbox{ALC on} & & \geq 2 \ \mbox{μs} \\ \mbox{ALC off} & & \geq 500 \ \mbox{ns} \\ \mbox{Resolution} & & 20 \ \mbox{ns (nom)} \\ \end{array}$

Pulse repetition frequency

 $\begin{array}{lll} \text{ALC on} & \text{DC to 500 kHz} \\ \text{ALC off} & \text{DC to 2 MHz} \\ \text{Level accuracy} & <1 \text{ dB (typ)} \end{array}$

(relative to CW, ALC on or off)

Video feedthrough < 250 mV (typ) 2 Pulse overshoot < 15% (typ) Pulse compression 5 ns (typ)

Pulse delay

RF delay (video to RF output) 10 ns (nom) Video delay (ext input to video) 30 ns (nom)

External input

Input impedance 50 Ω (nom)

Level +1 Vpeak = ON (nom)

^{1.} Pulse specifications apply to frequencies > 500 MHz. Operable down to 10 MHz.

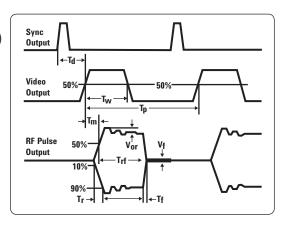
^{2.} Specification applies for power levels < 10 dBm.

Narrow pulse modulation

(Option UNW) 1

spaint office,		
On/Off ratio	500 MHz to 3.0 GHz > 80 dB (typ)	Above 3.0 GHz > 80 dB (typ)
Rise/Fall times (Tr, Tf)	< 10 ns; 7 ns (typ)	< 10 ns; 7 ns (typ)
Minimum pulse width	(-717)	(717)
Internally leveled	≥ 2 µs	≥ 2 µs
ALC off 2	≥ 20 ns	≥ 20 ns
Repetition frequency		
Internally leveled	10 Hz to 500 kHz	10 Hz to 500 kHz
ALC off ²	dc to 5 MHz	dc to 10 MHz
Level accuracy (relative to CW)		
Internally leveled	$< \pm 1.0 \text{ dB}$	$< \pm 1.0 \text{ dB}$
ALC off ²	$< \pm 1.0$ dB (typ)	$< \pm 1.0$ dB (typ)
Width compression	< 5 ns (typ)	< 5 ns (typ)
(RF width relative to video out)		
Video feed-through ³	< 50 mV (typ)	< 5 mV (typ)
Video delay (ext input to video)	20 ns (nom)	20 ns (nom)
RF delay (video to RF output)	10 ns (nom)	10 ns (nom)
Pulse overshoot	< 15% (typ)	< 15% (typ)
Input level	+1 Vpeak = RF On	+1 Vpeak = RF On
Input impedance	50 Ω (nom)	50 Ω (nom)

Td Video delay (variable)
Tw Video pulse width (variable)
Tp Pulse period (variable)
Tm RF delay
Trf RF pulse width
Tf RF pulse fall time
Tr RF pulse rise time
Vor Pulse overshoot



- 1. Pulse specifications apply to frequencies > 500 MHz. Operable down to 10 MHz.
- 2. With power search on.

Vf Video feedthrough

3. Video feed through applies to power levels < +10 dBm.

Internal pulse generator (included with Option UNU or Option UNW)

Modes Free-run, square, triggered, adjustable doublet,

trigger doublet, gated, and external pulse

Square wave rate 0.1 Hz to 10 MHz, 0.1 Hz resolution (nom)

Pulse period (UNU) 500 ns to 42 seconds (nom)

Pulse width (UNU) 500 ns to pulse period – 10 ns (nom)

Pulse period (UNW) 30 ns to 42 seconds (nom)

Pulse width (UNW) 20 ns to pulse period -10 ns (nom)

Resolution 10 ns

Adjustable trigger delay: -pulse period + 10 ns to pulse period

to pulse width -10 ns

Settable delay

Free run -3.99 to 3.97 µs
Triggered 0 to 40 s

Resolution

[delay, width, period] 10 ns (nom)

Pulse doublets
1st pulse delay

 $\begin{array}{ll} \text{(relative to sync out)} & 0 \text{ to } 42 \text{ s} - \text{pulse width} - 10 \text{ ns} \\ 1\text{st pulse width} & 500 \text{ ns to } 42 \text{ s} - \text{delay} - 10 \text{ ns} \\ \end{array}$

2nd pulse delay

(relative to pulse 1) 0 to 42 s - (delay1 + width2) - 10 ns 2nd pulse width 20 ns to 42 s - (delay1 + delay2) - 10 ns

Pulse train (Option 320)

Number of pulse patterns: 2047

On/off time range (UNU): 500 ns to 42 sec On/off time range (UNW): 20 ns to 42 sec

External modulation inputs ¹

Modulation types FM, AM, phase mod, pulse mod

Input impedance 50 Ω (nom)

Simultaneous modulation ²

All modulation types (FM, AM, ϕ M and pulse modulation) may be simultaneously enabled except: FM and phase modulation can not be combined; two modulation types can not be simultaneously generated using the same modulation source. For example the baseband generator, AM, and FM can run concurrently and all will modulate the output RF. This is useful for simulating signal impairments.

Option UNT required for FM, AM, and phase mod inputs. Option UNU or UNW required for pulse modulation inputs.

^{2.} If AM or pulse modulation are on then phase and FM specifications do not apply.

Vector Modulation

I/Q input and output data ¹

External I/Q inputs ²

Impedance 50 Ω (nom)

Bandwidth Up to 100 MHz baseband (nom)

Up to 200 MHz RF (nom)

 $\begin{array}{ll} \mbox{I offset} & \pm 100 \mbox{ mV} \\ \mbox{Q offset} & \pm 100 \mbox{ mV} \\ \mbox{Quadrature angle adjustment} & \pm 200 \mbox{ units} \end{array}$

For optimum ACPR/EVM performance up to specified RF output power. ³

Range	I, Q (rms)	rss
100 kHz to 1.2 GHz	132 mV	187 mV
1.2 GHz to 1.45 GHz	123 mV	174 mV
1.45 GHz to 2.2 GHz	114 mV	161 mV
2.2 GHz to 2.45 GHz	100 mV	141 mV
2.45 GHz to 3.0 GHz	81 mV	115 mV
3.0 GHz to 3.9 GHz	112 mV	158 mV
3.9 GHz to 4.5 GHz	132 mV	187 mV
4.5 GHz to 5.8 GHz	90 mV	127 mV
5.8 GHz to 6 GHz	25 mV	35 mV

Internal I/Q from baseband generator 4

I offset	±20%
Q offset	±20%
I/Q gain	±1 dB
Quadrature angle adjustment	±10°
I/Q phase	±360.00°
I/Q skew	±800.00 ns
I/Q delay	±400.00 ns
I/O delay resolution	1 picosecond

External I/Q outputs

Impedance 50 Ω (nom) per output

100 Ω (nom) differential output

Type Single ended or differential (Option 1EL)

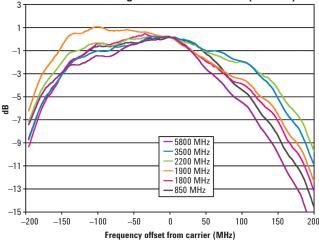
Maximum voltage per output ±2 V peak to peak; into high impedance

Bandwidth 50 MHz baseband (nom)

100 MHz RF (nom)

Common mode I/Q offset ±2.5 V into high impedance
Differential mode I offset ±25 mV into high impedance
Differential mode Q offset ±25 mV into high impedance

I/Q bandwidth using external I/Q source (ALC off)



I/Q adjustments represent user interface parameter ranges and not "specifications."

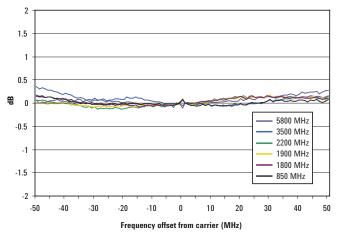
^{2.} ALC must be on while using external IQ inputs.

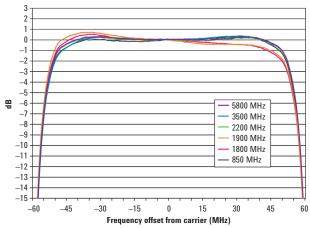
^{3.} ACPR/EVM degrades beyond listed RF output power.

^{4.} Internal IQ adjustments apply to RF out and IQ outputs simultaneously.

I/Q bandwidth plot using optional internal baseband generator (Internal Channel Corrections ON)²

I/Q bandwidth plot using optional internal baseband generator





Baseband Generator

(Options 651, 652, 654)

Channels 2 [I and Q]

Sample rate and bandwidth Clock rate Bandwidth Option 651 100 Sa/s to 30 MSa/s 24 MHz 100 Sa/s to 60 MSa/s 48 MHz Option 652 Option 654 100 Sa/s to 125 MSa/s 100 MHz

Reconstruction filter 50 MHz ± 50 MHz Baseband frequency offset range

Waveform switching speed

Туре	Standard	Option UNZ
SCPI mode ¹	≤ 5 ms (typ)	≤ 1.2 ms (typ)
List/Step sweep mode	≤ 5 ms (typ)	≤ 900 µs (typ)

Digital sweep modes

In list sweep mode each point in the list can have independent waveforms along with user definable frequencies and amplitudes. See the amplitude and frequency sections for more detail.

Data transfer rates

LAN to non-volatile storage 161 kSa/s (meas) LAN to baseband generator 265 kSa/s (meas) Non-volatile storage to

baseband generator 262 kSa/s (meas)

^{1.} SCPI mode switching speed applies when waveforms are pre-loaded in list sweep and sample rate \geq 10 MSa/s.

^{2.} Internal Channel Correction is available with firmware revision A.01.60 and Option N5182/62AK-R2C.

Arbitrary waveform memory

Maximum playback capacity 8 MSa, 64 MSa (Option 019)

Maximum storage capacity

including markers 800 MSa

Waveform segments

Segment length 60 samples to 8 MSa

60 samples to 64 MSa (Option 019)

Up to 2000 depending on memory usage

Maximum number of segments 1024, 8192 (Option 019)

in baseband generator playback

memory

Maximum number of segments 8192

in non-volatile memory

Minimum memory allocation 256 samples

per segment

Waveform sequences

Maximum number of sequences

Maximum number of

segments/sequence 1024
Maximum number of repetitions 65535

Triggers

Types Continuous, single, gated, segment advance,

LXI LAN, LXI ALARM 1

Source Trigger key, external, bus (GPIB, LAN, USB)

Modes

Continuous Free run, trigger and run, reset and run

Single No retrigger, buffered trigger,

immediate retrigger

Gated Negative polarity or positive polarity

Segment advance Single or continuous

External coarse delay time 8 ns to 30 s

External coarse delay resolution 8 ns

external coarse delay resolution 6 hs

Trigger latency ² 490 ns + 1 sample clock period (nom)

Trigger accuracy ² ±4 ns (nom)

Multi-baseband generator synchronization:

Fan out: 1 master and up to 15 slaves

Trigger repeatability: < 1 ns (nom)

Trigger accuracy: Same as normal mode

Trigger latency: Same as normal mode

Fine trigger delay range: See Internal IQ section

Fine trigger delay resolution: See Internal IQ section

IQ phase: See Internal IQ section

^{1.} LXI class B requires Option ALB. Standard on new instruments.

^{2.} Single trigger mode only.

Markers

[Markers are defined in a segment during the waveform generation process, or from the front panel. A marker can also be routed to the RF blanking and ALC Hold functions]

Marker polarity Negative, positive

Number of markers 4

Burst on / off ratio > 80 dB (typ)

AWGN [Option 403]

Type Real-time, continuously calculated and

played using DSP

Modes of operation Standalone or digitally added to arbitrary

waveform

Bandwidth ¹ 1 Hz to 100 MHz

Crest factor 15 dB

Randomness 90 bit pseudo-random generation, repetition

period 313 x 10⁹ years

Carrier to noise ratio \pm 100 dB when added to arbitrary

waveforms

Carrier to noise ratio error Magnitude error ≤ 0.2 dB at baseband I/Q

outputs

^{1.} Maximum bandwidth depends on installed baseband generator options.

Custom modulation (Option 431)

Multicarrier

Number of carriers Up to 100 [limited by a max bandwidth of

80 MHz depending on symbol rate and

modulation type]

Frequency offset [per carrier] -40 MHz to +40 MHz Power offset [per carrier] 0 dB to -40 dB Symbol rate 50 sps to 62.5 Msps

Nyquist, Root Nyquist, Gaussian, Filter types

Rectangular, APCO 25 C4EM, user

Modulation

PSK BPSK, QPSK, OQPSK, π/4DQPSK,

> 8PSK, 16PSK, D8PSK 4, 16, 32, 64, 128, 256

QAM FSK Selectable: 2, 4, 8, 16 MSK

ASK

Quick Setup modes APCO 25w/C4FM, APCO25 w/CQPSK,

> Bluetooth, CDPD, DECT, EDGE, GSM, NADC, PDC, PHS, PWT, TETRA

Data Random only

Multitone and two-tone (Option 430)

Number of tones 2 to 64, with selectable on/off state per tone

100 Hz to 100 MHz Frequency spacing Fixed or random Phase [per tone]

Real-time Phase Noise Impairments (Option 432)

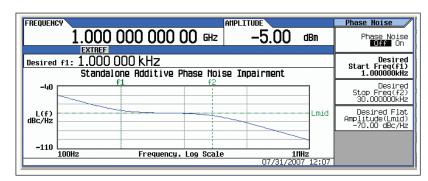
Close-in phase noise characteristics -20 dB/decade slope Far-out phase noise characteristics -20 dB/decade slope

Mid frequency characteristics

Start frequency (f1) Offset settable from 0 to 48 MHz Offset settable from 0 to 48 MHz Stop frequency (f2)

Phase noise amplitude level (L(f)) User selected; max degradation dependent

on f2



Format	GSM		EDGE		cdm	a2000/	1xEV-DC)	W-CI	DMA	Ľ	TE FDD ³
		. 1\		201/								
Modulation type	GMSK (bursted) 3pi/8 8PSK bursted)			QPS	SK			QPSK		б	4 QAM	
Modulation rate	270.833 ksp	S	70.833	(sps	1.22	88Mcps	3		3.841	/lcps		
Channel configura- tion	1 timeslot		1 times	lot	pilot	t chann	el		1DPC	CH		
Frequency ⁴	800 to 900 M 1800 to 1900 MHz			000 MHz 1900 MHz		to 900 l 0 to 190			1800 2200	to MHz		800 to 200 MHz
EVM power level	≤7 dBm		≤7 dBn	n	≤ 7	dBm			≤ 7 d	Bm	<u> </u>	7 dBm
EVM power level with Option 1EA	≤ 13 dBm		≤ 13 dB	m	≤ 13	3 dBm			≤ 13	dBm	<u> </u>	13 dBm
EVM	Global phas error	е										
	Spec 1	уре	Spec	Туре	Spe	С	Туре		Spec	Ту	/pe	
	ms 0.8 ° 0).2 °	1.2%	0.7%	1.3%	6	0.8%	ı	1.2%	0.		.45% neasured)
	peak 1.5° ().6 °										
Format	802.11a/g		802.16e W	/iMAX ⁵		QP	SK ⁶			160	AM ⁶	
Modulation type	64QAM		64QAM			QF	PSK		16QAM			
Modulation rate	54 Mbps		_			4 N	1Sps			4 N	/ISps	
Frequency ⁴	2400 to 2484 MHz		2300 to 26	90 MHz	≤ 3	GHz	≤ 6	GHz	≤	3 GHz	≤	6 GHz
	5150 to 5825 MHz		3300 to 38	00 MHz								
EVM power level	≤ –5 dBm		≤ 2 dBm		≤ 4 (dBm	≤ 4 (dBm	≤ 4 dBm		<u>≤</u>	4 dBm
EVM power level with Option 1EA	≤ 2 dBm		≤8 dBm		≤ 10	dBm	≤ 10	dBm	≤ ′	10 dBm	≤ '	10 dBm
EVM	.51% (mea- sured)		0.4% (mea	sured)	Spec	Туре	Spec	Туре	Spec	Туре	Spec	Туре
					1.2%	0.8%	1.9%	1.1%	1.1%	0.6%	1.5%	0.9%

^{1.} EVM specifications apply for the default ARB file setup conditions with the default ARB files supplied with the instrument.

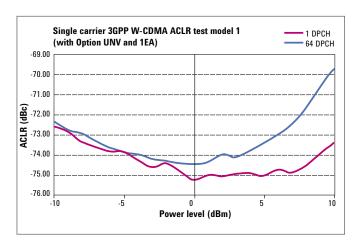
^{2.} EVM specifications apply after execution of an I/Q calibration when the instrument is maintained within ± 5 °C of the calibration temperature.

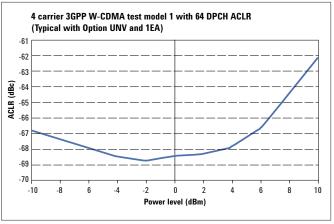
3. LTE FDD E-TM 3.1, 10 MHz, 64 QAM PDSCH, full resource block.

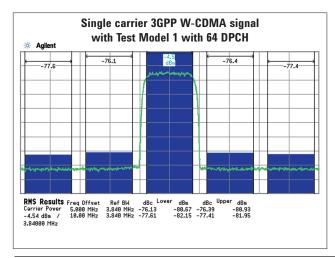
^{4.} Performance evaluated at bottom, middle and top of bands shown.

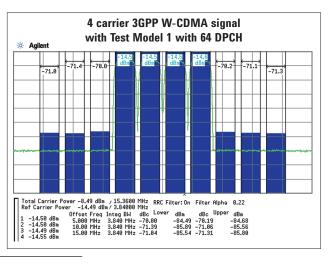
^{5. 802.16}e WiMAX signal configuration: bandwidth: 10 MHz, FFT: 1024, frame length: 5 ms, guard period: 1/8, symbol rolloff: 5%, content: 30 symbols of PN9 data.
6. The QPSK and 16QAM signals were tested with a root Nyquist filter with α = 0.2.

3GPP W-CDMA distortion performance									
Offset	Configuration	Frequency	Star	ndard	Option	n UNV	Option UI Option		
Power level			≤ –7	dBm ¹	≤ -7	dBm ¹	≤ 5 dE	3m ¹	
			Spec	Туре	Spec	Туре	Spec	Туре	
Adjacent (5 MHz)	1 DPCH, 1 carrier	1800 to 2200 MHz	-68 dBc	–70 dBc	–71 dBc	–73 dBc	–71 dBc	–73 dBc	
Alternate (10 MHz)			–69 dBc	–70 dBc	–71 dBc	–75 dBc	−71 dBc	–75 dBc	
Adjacent (5 MHz)	Test model 1 with	1800 to 2200 MHz	-64 dBc	-65 dBc	–71 dBc	–73 dBc	–71 dBc	-73 dBc	
Alternate (10 MHz)	64 DPCH, 1 carrier		−67 dBc	–67 dBc	–71 dBc	–75 dBc	–71 dBc	–75 dBc	
Adjacent (5 MHz)	Test model 1 with	1800 to 2200 MHz	–57 dBc	–59 dBc	–65 dBc	–67 dBc	-64 dBc	-66 dBc	
Alternate (10 MHz)	64 DPCH, 4 carrier	-	–57 dBc	-60 dBc	−66 dBc	–68 dBc	-66 dBc	−66 dBc	



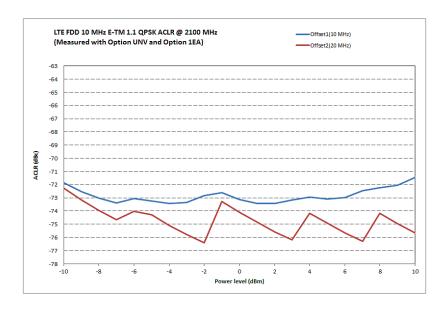




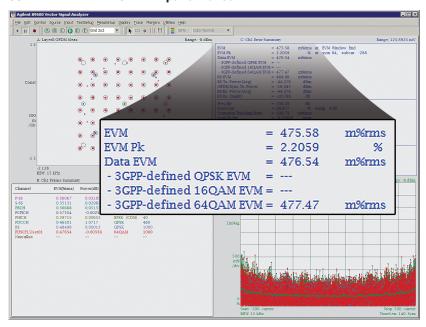


^{1.} This is rms power. How to convert from rms to peak envelope power (PEP): PEP = rms power + crest factor. Example: 3GPP test model 1 with 64 DPCH has a crest factor >11 dB, therefore at +5 dBm rms, the PEP = 5 dBm + 11 dB = +16 dBm PEP.

LTE FDD distortion performance									
Power level	Offset	Configuration ^{1,2}	Frequency	Standard (meas)	UNV (meas)				
≤ 5 dBm	10 MHz	E-TM 1.1	2.1 GHz	-68	-72				
≤ 5 dBm	20 MHz	E-TM 1.1	2.1 GHz	-69	-73				



3GPP LTE FDD E-TM 3.1 EVM performance



^{1.} LTE FDD 10 MHz E-TM 1.1 QPSK.

^{2.} Measurement configuration: reference channel integration BW: 9.015 MHz, offset channel integration BW: 9.015 MHz, channel offset: 10 MHz and 20 MHz

GSM / EDGE output RF spectrum (ORFS) 1

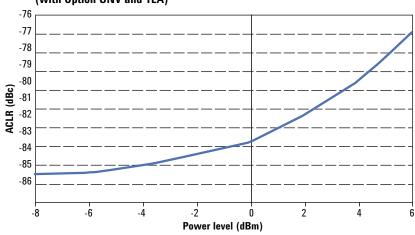
			G	SIVI	EU	
Offset	Configuration	Frequency ²	Standard	Option UNV	Standard	Option UNV
(typ)			(typ)	(typ)	(typ)	(typ)
200 kHz	1 normal	800 to	–33 dBc	–37 dBc	–35 dBc	–39 dBc
400 kHz	timeslot.	900 MHz	−67 dBc	-71 dBc	−67 dBc	-71 dBc
600 kHz	bursted	1800 to	-79 dBc	-83 dBc	–78 dBc	-82 dBc
800 kHz	buisteu	1900 MHz	−80 dBc	-84 dBc	−80 dBc	-84 dBc
1200 kHz]	1300 101112	-82 dBc	-86 dBc	-81 dBc	-85 dBc

3GPP2 cdma2000 distortion performance

Offset	Configuration	Frequency	Standard (typ)	Option UNV (typ)	Option UNV with Option 1EA (typ)	
			Power $\leq -7 \text{ dBm }^3$	Power $\leq -7 \text{ dBm }^3$	Power $\leq 5 \text{ dBm }^3$	
885 kHz to 1.98 MHz	9 channel	800 to 900 MHz	-78 dBc	-79 dBc	-77 dBc	
> 1.98 to 4.0 MHz	forward link	1800 to 2200 MHz	-83 dBc	–87 dBc	-87 dBc	
> 4.0 to 10 MHz			-88 dBc	–93 dBc	-93 dBc	

FDCF

3GPP2 cdma2000 ACLR 9 channel forward link (with Option UNV and 1EA)



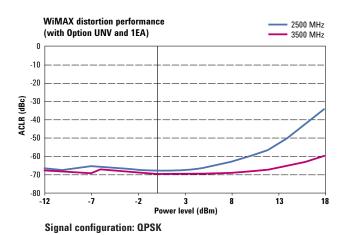
^{1.} Specifications apply for power levels \leq +7 dBm.

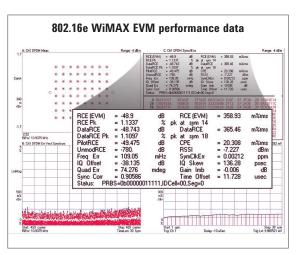
^{2.} Performance evaluated at bottom, middle and top of bands shown.

^{3.} This is rms power. How to convert from rms to peak envelope power (PEP): PEP = rms power + crest factor. Example: 3GPP Test model 1 with 64 DPCH has a crest factor >11 dB ,therefore at +5dBm rms the PEP = 5 dBm + 11dB = +16 dBm PEP.

802.16e mobile WiMAX distortion performance ¹

Power level	Offset	Configuration ^{1,2}	Frequency	Standard (n	neas) UNV (meas)
< -7 dBm ³	10 MHz	QPSK	2.5 and 3.5 GHz	-62 dBc	-66 dBc
Up to +5 dBm ³	10 MHz	QPSK	3.5 GHz	-61 dBc	-65 dBc





Signal configuration: Downlink signal, 30 symbols, 64QAM,

10 MHz bandwidth

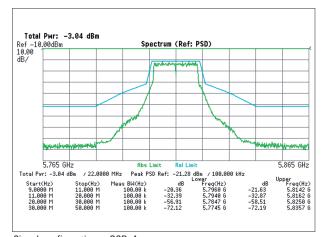
Power level: -7 dBm

1. 802.16e WiMAX signal configuration: bandwidth: 10 MHz, FFT: 1024, frame length: 5 ms, guard period: 1/8, symbol rolloff: 5%, content: 30 symbols of PN9 data.

 Measurement configuration: reference channel integration BW: 9.5 MHz, offset channel integration BW: 9 MHz, channel offset: 10 MHz.

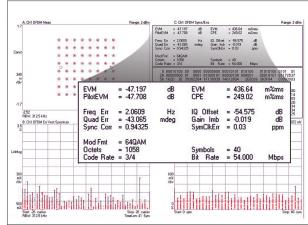
3. This is rms power. How to convert from rms to peak envelope power (PEP): PEP = rms power + crest factor. Example: 3GPP test model 1 with 64 DPCH has a crest factor >11 dB, therefore at +5 dBm rms, the PEP = 5 dBm + 11 dB = +16 dBm PEP.

WLAN



Signal configuration: OSR: 4
Window length: 16
Power level: 0 dBm
Carrier frequency: 5.805 GHz

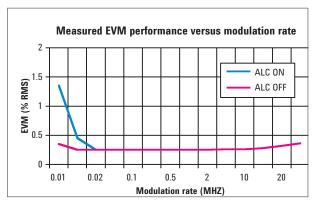
802.11a WLAN spectral mask performance



Signal configuration: OSR: 4
Window length: 16
Power level: 0 dBm
Carrier frequency: 5.805 GHz

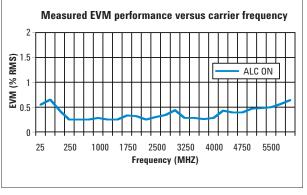
802.11a WLAN EVM performance

QPSK



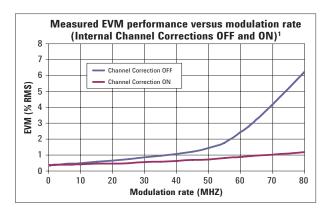
Signal configuration: QPSK modulation

Alpha: 0.25 Power level: +4 dBm Carrier frequency 2.2 GHz



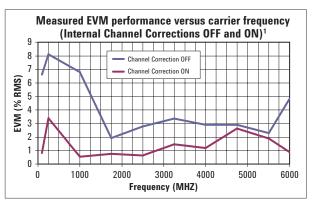
Signal configuration: QPSK modulation

Alpha: 0.25
Power level: +4 dBm
Symbol rate: 4 MSymb/s



Signal configuration: QPSK modulation

Alpha: 0.25 Power level: +4 dBm Carrier frequency 2.2 GHz



Signal configuration: QPSK modulation

Alpha: 0.25
Power level: +4 dBm
Symbol rate: 62.5 MSymb/s

^{1.} Internal Channel Correction is available with firmware revision A.01.60 and Option N5182/62AK-R2C.

General Characteristics

Remote programming

Interfaces GPIB IEEE-488.2, 1987 with listen and talk

LAN 100BaseT LAN interface,

LXI class C compliant ²

USB Version 2.0 Control languages SCPI Version 1997.0

Compatibility languages supporting 100% of commonly used commands ¹

Agilent Technologies E4438C, E4428C, E442xB, E443xB, E8241A,

E8244A, E8251A, E8254A, E8247C, E8257C/D, E8267C/D, 8648 series, 8656B, E8663B, 8657A/B

Aeroflex Incorporated 3410 series

Rohde & Schwarz SMU200A, SMJ100A, SMATE200A, SMIQ,

SML, SMV

0 to 55 °C

Power requirements 100 or 120 VAC, 50 or 60 Hz, 400 Hz

220 or 240 VAC, 50 or 60 Hz

250 W maximum

Operating temperature range Storage temperature range Operating and storage altitude

-40 to 70 °C Up to 15,000 feet

Environmental stress

Samples of this product have been type tested in accordance with the Agilent Environmental Test Manual and verified to be robust against the environmental stresses of Storage, Transportation and End-use; those stresses include but are not limited to temperature, humidity, shock, vibration, altitude and power line conditions. Test Methods

to MIL-PRF-28800F Class 3.

Safety Complies with European Low Voltage Directive

73/23/EEC, amended by 93/68/EEC

are aligned with IEC 60068-2 and levels are similar

· IEC/EN 61010-1

· Canada: CSA C22.2 No. 61010-1

· USA: UL 61010-1

EMC Complies with European EMC Directive

89/336/EEC, amended by 93/68/EEC

· IEC/EN 61326

· CISPR Pub 11 Group 1, class A · AS/NZS CISPR 11:2002

· ICES/NMB-001

Memory is shared by instrument states, user

data files, sweep list files, waveform sequences, and other files. There are 4 GB of flash memory available in the N5182A MXG. Depending on how the memory is utilized, a maximum of 1000

instrument states can be saved.

Security (Option 006) Memory sanitizing, memory sanitizing on power

on, and display blanking

Self test Internal diagnostic routines test most modules in

a preset condition. For each module, if its node voltages are within acceptable limits, the

module "passes" the test.

^{1.} Firmware version A.01.10 and later.

^{2.} LXI class B compliant with Option ALB.

Weight dimensions \leq 12.5 kg (27.5 lb.) net, \leq 27.2 kg (60 lb.) shipping 88 mm H x 426 mm W x 432 mm L [3.5 in H \times 16.8 in W \times 17 in L]

Recommended calibration cycle

36 months. Agilent is committed to providing you with the lowest total cost to own and operate equipment. In support of this commitment, Agilent has verified that the stability of this product's architecture justifies a longer calibration inte val of 3 years.

ISO compliant

The Agilent N5182A MXG is manufactured in an ISO-9001 registered facility in concurrence with Agilent Technologies' commitment to quality.

Outputs the RF signal via a precision N type female connector.

Maximum reverse power is 2 W, 50 VDC.

Front panel connectors 1

RF output ²

I and Q inputs 2

USB 2.0

modulation. Nominal input impedance is 50 Ω . Damage levels are 1 Vrms and 5 Vpeak. Used with a memory stick for transferring instrument states, licenses and other files into or out of the instrument. Also used with U2000 Series USB average power sensors. For a current list of supported memory sticks, visit

Accepts "in-phase" and "quadrature" input signals for I/Q

www.aqilent.com/find/MXG, click on Technical Support. and refer to FAQs: Waveform Downloads and Storage.

Outputs the RF signal via a precision N type female connector.

Accepts "in-phase" and "quadrature" input signals for I/Q

Outputs the analog I/Q modulation signals from the internal baseband generator. Nominal output impedance 50 Ω .

Outputs the complement of the I and Q signals for differential

modulation. SMB connector, nominal input impedance is $50~\Omega$. Damage levels are 1 Vrms and 5 Vpeak. Option 1EM and N5162A units will come with 2 SMB to BNC adapters.

Rear panel connectors 1

RF output (Option 1EM or N5162A) I and Q inputs (Option 1EM or N5162A)

I and Q outputs

 \overline{I} and \overline{Q} outputs (Option 1EL)

EXT Clk Event 1

applications. Nominal output impedance is 50 Ω , DC-coupled. Damage levels are ±2 V. Reserved for future use.

DC coupled. Damage levels ±2 V.

This connector outputs the programmable timing signal generated by marker 1. The marker signal can also be routed internally to control the RF blanking and ALC hold functions. This signal is also available on the AUX I/O connector. This output is TTL and 3.3 V CMOS compatible. Damage

levels are > +8 V and < -4 V.

Pattern trigger Accepts signal to trigger internal pattern generator to start single pattern output, for use with the internal baseband

generator (Option 651, 652, 654), Accepts CMOS ³ signal with minimum pulse width of 100ns. Female BNC; Damage levels

are > +8 V and < -4 V.

Sweep out Generates output voltage, 0 to +10 V when the signal

generator is sweeping. This output can also be programmed to indicate when the source is settled or output pulse video and

is TTL and CMOS compatible in this mode. Output

impedance < 1 Ω , can drive 2 k Ω . Damage levels are ±15 V.

^{1.} All connectors are BNC unless otherwise noted

^{2.} All N5162A MXG ATE connectors located on rear panel.

^{3.} Rear panel inputs and outputs are 3.3 V CMOS, unless indicated otherwise. CMOS inputs will accept 5 V CMOS, 3 V CMOS, or TTL voltage levels.

External AM input. Nominal input impedance is 50 Ω . AM

Damage levels are ±5 V.

FM External FM input. Nominal input impedance is 50 Ω .

Damage levels are ±5 V.

Pulse External pulse modulation input. This input is TTL and

> CMOS compatible. Low logic levels are 0 V and high logic levels are +1 V. Nominal input impedance is 50 Ω . Input

damage levels are ≤ -0.3 V and $\geq +5.3$ V.

Trigger in Accepts TTL and CMOS level signals for triggering

point-to-point in sweep mode. Damage levels are ≤ -0.3 V

and ≥ +5.3 V.

Trigger out Outputs a TTL and CMOS compatible level signal for use

> with sweep mode. The signal is high at start of dwell, or when waiting for point trigger in manual sweep mode; low when dwell is over or point trigger is received. This output can also be programmed to indicate when the source is settled, pulse synchronization, or pulse video. Nominal output impedance 50 ohms. Input damage levels are

 $\leq -0.3 \text{ V} \text{ and } \geq +5.3 \text{ V}.$

Reference input Accepts a 10 MHz reference signal used to frequency lock

> the internal timebase. Option 1ER adds the capability to lock to a frequency from 1 MHz to 50 MHz. Nominal input level -3.5 to +20 dBm, impedance 50 Ω , sine or square

10 MHz out Outputs the 10 MHz reference signal used by internal

> timebase. Level nominally +3.9 dBm. Nominal output impedance 50 Ω . Input damage level is +16 dBm. Accepts a signal from a master signal generator that is

LO in (Option 012)

used as the LO for MXG vector in order to configure a phase coherent system. Nominal input levels between 0 to

+7 dBm. Nominal input impedance 50 Ω .

LO out (Option 012) Outputs a reference signal that can be used in a phase

coherent system. Nominal output levels between 0 to

7 dBm. Nominal output impedance 50 Ω .

Digital bus I/O Reserved for future use.

Aux IO

USB 2.0

The AUX I/O connector provides additional digital signal

(50 pin SCSI II connector) outputs as follows.

> Event 1 - 4 (Pin 1 - 4) This connector outputs programmable timing signals generated by markers 1 - 4. The marker signals can also routed internally to control the RF blanking and ALC hold functions. This output is TTL and 3.3 V CMOS

compatible. Damage levels are > +8 V and < -4 V. The USB connector provides remote programming

functions via SCPI.

LAN (100 BaseT) The LAN connector provides the same SCPI remote

> programming functionality as the GPIB connector. The LAN connector is also used to access the internal web server and FTP server. The LAN supports DHCP, sockets SCPI, VXI-11 SCPI, connection monitoring, dynamic hostname services, TCP keep alive. This interface is LXI class C and B compliant. Trigger response time for the immediate LAN trigger is 0.5 ms (minimum), 4 ms (maximum), 2 ms typical; delayed/alarm triger is unknown. Trigger output response time is 0.5 ms (minimum), 4 ms (maximum), 2 ms typical.

GPIB The GPIB connector provides remote programming

functionality via SCPI.

30

Ordering Information

Frequency	503 506	Frequency range from 100 kHz to 3 GHz Frequency range from 100 kHz to 6 GHz
Performance enhancements	UNZ 1EA 1EQ UNU UNW 320 UNT 006 1ER 1EM UK6 099 012	Fast switching High output power Low power (< -110 dBm) Pulse modulation Narrow pulse modulation Pulse train generator AM, FM, phase modulation Instrument security Flexible reference input (1-50 MHz) Move RF output to rear panel 1 Commercial calibration certificate with test data Expanded license key upgradeability 2 LO in/out for phase coherency
Vector specific options	651 652 654 019 1EL 403 UNV 430 431 432 221-229 250-259	Internal baseband generator (30 MSa/s, 8 MSa) Internal baseband generator (60 MSa/s, 8 MSa) Internal baseband generator (125 MSa/s, 8 MSa) Increase baseband generator memory to 64 MSa Differential I/Q outputs Calibrated AWGN Enhanced dynamic range Multitone and two-tone Custom digital modulation Phase noise impairments Waveform license 5-packs 1 to 9 (purchase up to 9 packs for 45 Signal Studio waveforms) Waveform license 50-packs 1 to 10 (purchase up to 10 packs for 500 Signal Studio waveforms)
Signal Studio software	N7600B N7601B N7602B N7606B N7611B N7612B N7613A N7615B N7616B N7617B N7621B N7622A N7623B N7624B N7624B	Signal Studio for 3GPP W-CDMA with HSDPA/HSUPA Signal Studio for 3GPP2 CDMA Signal Studio for GSM/EDGE Signal Studio for Bluetooth Signal Studio for broadcast radio Signal Studio for TD-SCDMA Signal Studio for 802.16-2004 (WiMAX) Signal Studio for 802.16 WiMAX Signal Studio for 802.16 WiMAX Signal Studio for T-DMB Signal Studio for 802.11 WLAN Signal Studio for multitone distortion test Signal Studio toolkit Signal Studio for digital video Signal Studio for 3GPP LTE Signal Studio for 3GPP LTE TDD
Accessories	1CM 1CN 1CP 1CR AXT 800	Rackmount kit Front handle kit Rackmount and front handle kit Rack slide kit Transit case Customer service kit front panel RF connector configuration (Parts kit enables owners to repair the MXG on site, includes internal replacement parts, tools, and a calibrated RF module.) Customer service kit rear panel (1EM) RF connector configuration (Parts kit enables owners to repair the MXG on site, includes internal replacement parts, tools, and a calibrated RF module.)

Not available on N5162A MXG ATE.
 For more information on upgrades and
 Option 099 refer to Agilent MXG Signal
 Generator Configuration Guide, literature number 5989-5485EN.

Archive Section

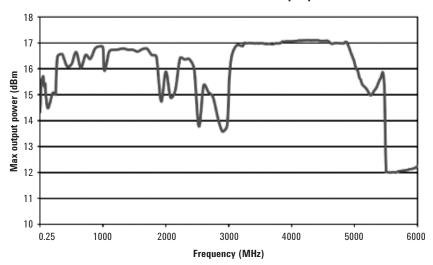
Frequency

Minimum frequency 100 kHz ¹

Output power	
(for serial number	
prefix 4742xxxx)	

Range ²	Standard	Option 1EQ ³
100 kHz to 250 kHz	-110 to +4 dBm	-127 to +4 dBm
> 250 kHz to 2.5 GHz	-110 to +13 dBm	-127 to +13 dBm
> 2.5 to 3.0 GHz	-110 to +10 dBm	-127 to +10 dBm
> 3.0 to 4.5 GHz	-110 to +13 dBm	-127 to +13 dBm
> 4.5 to 5.8 GHz	-110 to +10 dBm	-127 to +10 dBm
> 5.8 to 6 GHz	-110 to +7 dBm	-127 to +7 dBm

Measured maximum available output power



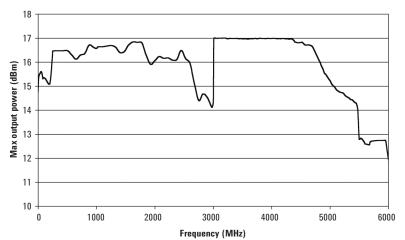
^{3.} Settable to -144 dBm with Option 1EQ, but unspecified below -127 dBm.

Output power	Range ²	Standard	Option 1EQ ³
(for serial number	250 kHz to 2.5 GHz	-110 to +13 dBm	-127 to +13 dBm
prefixes lower than	> 2.5 to 3.0 GHz	-110 to +10 dBm	-127 to +10 dBm
4742xxxx)	> 3.0 to 4.5 GHz	-110 to +13 dBm	-127 to +13 dBm
	> 4.5 to 5.8 GHz	-110 to +10 dBm	-127 to +10 dBm
	> 5.8 to 6 GHz	-110 to +7 dBm	-127 to +7 dBm

Performance below 250 kHz is unspecified for units with serial numbers lower than 4742xxxx.

Quoted specifications between 20 and 30 °C. Maximum output power typically decreases by 0.2 dB/°C for temperatures outside of this range.

Maximum available output power



	. , ,	•
SWR (for serial number prefix 4742xxxx)	≤ 2.1 GHz> 2.1 GHz to 4 GHz> 4.0 GHz 5.6 GHz> 5.6 GHz to 6 GHz	1.4:1 (typ) 1.5:1 (typ) 1.7:1 (typ) 2.0:1 (typ)
Maximum	Max DC voltage	50 VDC (nom)
reverse power	250 kHz to 6 GHz	2 W (nom)
SWR (for serial number prefixes lower than 4742xxxx)	≤ 1.4 GHz > 1.4 GHz to 4 GHz > 4.0 GHz 5.0 GHz > 5.0 GHz to 6 GHz	1.7:1 (typ) 2.3:1 (typ) 2.4:1 (typ) 2.2:1 (typ)
Maximum	Max DC voltage	50 VDC (nom)
reverse power	50 kHz to 6 GHz	2 W (nom)

Absolute level accuracy in CW mode ¹ [ALC on]

(for serial number prefix 4742xxxx)

	Standard		Option 1EQ
	+7 ² to -60 dBm	< -60 to -110 dBm	< -110 to -127 dBm
100 kHz to 250 kHz	±0.6 dB	±1.0 dB	
> 250 kHz to 1 MHz	±0.6 dB	±0.7 dB	±1.7 dB
> 1 MHz to 1 GHz	±0.6 dB	±0.7 dB	±1.0 dB
> 1 GHz to 3 GHz	±0.7 dB	±0.9 dB	±1.4 dB
> 3 GHz to 4 GHz	±0.8 dB	±0.9 dB	±1.0 dB
> 4 GHz to 6 GHz	±0.8 dB	±1.1 dB	±1.3 dB

Absolute level accuracy in CW mode ¹ [ALC on]

(for serial number prefixes lower than 4742xxxx)

	Standard		Option 1EQ
	+7 to -60 dBm	< -60 to -110 dBm	< -110 to -127 dBm
250 kHz to 1 MHz	±0.6 dB	±0.7 dB	±1.7 dB
> 1 MHz to 1 GHz	±0.6 dB	±0.7 dB	±1.0 dB
> 1 GHz to 3 GHz	±0.7 dB	±0.9 dB	±1.4 dB
> 3 GHz to 4 GHz	±0.8 dB	±0.9 dB	±1.0 dB
> 4 GHz to 6 GHz	±0.8 dB	±1.1 dB	±1.3 dB

^{1.} Quoted specifications between 20 and 30 °C. For temperatures outside of this range, absolute level accuracy degrades by 0.01 dB/ °C for frequencies \leq 4.5 GHz and 0.02 dB/ °C for frequencies > 4.5 GHz.

Level accuracy specified to +7 dBm or maximum specified output power, whichever is lower.

Spectral Purity

(for serial numbers lower than 4818xxxx)

Harmonics ¹ [CW mode, output level < 4 dBm]

250 kHz to 3 GHz < -30 dBc > 3 GHz to 6 GHz < -44 dBc (typ)

Nonharmonics ¹ [CW mode], > 10 kHz offset

Subharmonics ¹ [CW mode]

≤ 4 GHz
> 4 GHz to 5 GHz
> 5 GHz to 5.5 GHz
< -64 dBc
> 5 GHz to 5.5 GHz
< -50 dBc
> 5.5 GHz to 6 GHz
< -46 dBc</pre>

Related Literature

Application literature

- RF Source Basics, a self-paced tutorial (CD-ROM), literature number 5980-2060E.
- Accurate amplifier ACLR and ACPR testing with the Agilent MXG Vector Signal Generator, literature number 5989-5471EN
- Improving Throughput with Fast RF Signal Generator Switching, literature number 5989-5487EN
- Digital Modulation in Communications Systems-An Introduction, Application Note 1298, literature number 5965-7160E.
- Testing CDMA Base Station Amplifiers, Application Note 1307, literature number 5967-5486E.

Product literature

- Agilent MXG Signal Generator, Brochure, literature number 5989-5074EN
- · Agilent MXG Signal Generator, Configuration Guide, literature number 5989-5485EN
- Agilent N5181A analog signal generator, Data Sheet, literature number 5989-5311EN
- E4438C ESG Vector Signal Generator, Brochure, literature number 5988-3935EN.
- E4438C ESG Vector Signal Generator, Configuration Guide, literature number 5988-4085EN.
- E4438C ESG Vector Signal Generator, Data Sheet, literature number 5988-4039EN

Harmonics, sub-harmonics, and nonharmonics outside the frequency range of the instrument are typical.

See the Agilent MXG Web page for the latest information. Get the latest news, product and support information, application literature, firmware upgrades and more at:

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Revised: October 14, 2010

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